

# AMD Embedded G-Series System-on-Chip (SOC)

THE EMBEDDED EVOLUTION CONTINUES WITH X86 CPU, INTEGRATED DISCRETE-CLASS GPU AND I/O CONTROLLER ON THE SAME DIE

## **PRODUCT OVERVIEW**

The AMD Embedded G-Series SOC platform is a high-performance, low-power System-on-Chip (SOC) design, featured with enterprise-class error-correction code (ECC) memory support, dual and quad-core variants, integrated discrete-class GPU and I/O controller on the same die.

The AMD G-Series SOC achieves superior performance per watt in the low-power x86 microprocessor class of products when running multiple industry standard benchmarks.<sup>1</sup> This helps enable the delivery of an exceptional HD multimedia experience and provides a heterogeneous computing platform for parallel processing. The small-footprint, ECC-capable SOC sets the new foundation for a power-efficient platform for content-rich multimedia processing and workload processing that is well-suited for a broad variety of embedded applications.

## SUPERIOR PERFORMANCE PER WATT

The AMD Embedded G-Series SOC platform delivers an exceptionally high-definition visual experience and the ability to take advantage of heterogeneous computing while maintaining a low-power design.

- > AMD G-Series SOC's next-generation "Jaguar" based CPU offers 113% improved CPU performance vs. AMD G-Series APU and greater than a 2x (125%) advantage vs. Intel Atom when running multiple industrystandard compute-intensive benchmarks.<sup>2</sup>
- > AMD G-Series SOC's advanced GPU, supporting DirectX<sup>®</sup> 11.1, OpenGL 4.2 and OpenCL<sup>™</sup> 1.2<sup>9</sup>, enables parallel processing and high-performance graphics processing that provides up to 20% improvement vs. AMD G-Series APU and a 5x (430%) advantage vs. Intel Atom when running multiple industry-standard graphics-intensive benchmarks.<sup>3</sup>
- > Excellent compute and graphics performance with enhanced hardware acceleration delivers up to 70% overall improvement vs. AMD G-Series APU and over 3x (218%) the overall performance advantage vs. Intel Atom in embedded applications when running multiple industry-standard compute- and graphics-intensive benchmarks.<sup>4</sup>

## ENABLING LOW-POWER, INNOVATIVE SMALL FORM FACTOR DESIGNS

The AMD G-Series SOC is a small footprint and low-power solution that reduces overall system costs.

- > The SOC design offers 33% footprint reduction compared to AMD G-Series APU two-chip platform<sup>5</sup>, simplifying design with fewer board layers and simplified power supply.
- > AMD G-Series SOC enables fan-less design that further helps drive down system cost and enhance system reliability by eliminating moving parts.
- > With an array of performance options, the AMD G-Series SOC platform allows OEMs to utilize a single board design to enable solutions from entry-level to high-end.
- > The SOC design enables new levels of performance in small SBC (single board computer) and COMs (computer-on-modules) form factors.

## **OPTIMIZING BUSINESS VALUE**

The AMD Embedded G-Series SOC platform brings performance and efficiency with desirable features, delivering lower TCO and higher ROI.

- > Supporting ECC memory, AMD G-Series SOC platforms will help to penetrate markets previously inaccessible to x86 products in these power envelopes, at this price point.
- > The AMD G-Series SOC helps achieve higher system quality, reliability, and energy efficiency, which contribute to overall lower TCO.
- > Multiple performance levels offer upgrade paths to protect software and hardware ecosystem costs.
- > AMD's standard embedded 5 year availability and support (additional 2 years under contract possible) maximizes ROI.
- > The AMD G-Series SOC platform is well-suited for low-power and high-performance designs in a broad range of markets including Industrial Control & Automation, Digital Signage, Thin Client, Electronic Gaming Machines, and SMB storage appliances.



### **KEY ARCHITECTURE BENEFITS**

#### FIRST GENERATION SOC DESIGN

- $>\,$  Delivers up to 70% overall improvement over AMD G-Series APU^{6}
- > Integrates Controller Hub functional block as well as CPU+GPU+NB
- > 28nm process technology, 24.5mm x 24.5mm BGA package

#### "JAGUAR" CPU CORE WITH PERFORMANCE INCREASES

- > Dual-core and quad-core, up to 2MB shared L2
- > 113% CPU performance improvement over AMD G-Series APU<sup>7</sup>

#### NEXT GENERATION GRAPHICS CORE WITH PERFORMANCE INCREASE OVER PREVIOUS GENERATIONS

- > 20% compute performance improvement over AMD G-Series APU when running multiple industry-standard graphics-intensive benchmark
- > DirectX<sup>®</sup> 11.1 graphics support

#### **IMPROVED POWER SAVING FEATURES**

- > Power gating added to Multimedia Engine, Display Controller & NB
- > DDR P-states for reduced power consumption

#### MEMORY SUPPORT: SINGLE-CHANNEL DDR3

- > Up to DDR3-1600 1.35V and 1.25V voltage levels supported
- > Up to 2 UDIMMs or 2 SO-DIMMs
- > ECC support

#### INTEGRATED DISPLAY OUTPUTS

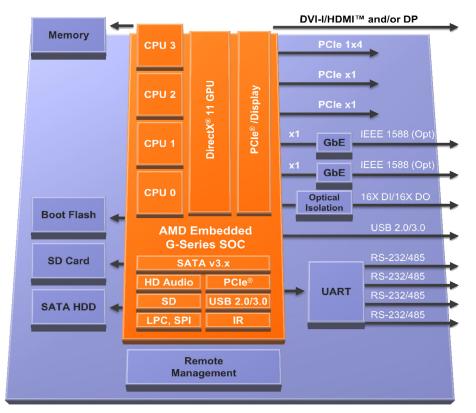
- > Supports two simultaneous displays
- > Supports 4-lane DisplayPort 1.2, DVI, HDMI™ 1.4a
- > Integrated VGA
- > Integrated eDP or 18bpp single channel LVDS

#### UPDATED I/O (FEATURES MAY BE SKU DEPENDENT)

- > Four x1 links of PCIe® Gen 2 for GPPs
- > One x4 link of PCIe Gen 2 for discrete GPU
- > 8 USB 2.0 + 2 USB 3.0
- > 2 SATA 2.x/3.x (up to 6Gb/s)
- > SD Card Reader v3.0 or SDIO controller

MODEL	OPN	# OF x86 CORES	TDP (CPU, GPU, & SB)	SHARED L2 CACHE	CPU FREQ.	GPU FREQ. (GRAPHICS)	DDR SPEED	USB 3.0	тјС
w/GPU									
GX-420CA	GE420CIAJ44HM	4	25W	2MB	2.0GHz	600MHz (HD 8400E)	DDR3-1600	Yes	90°C
GX-415GA	GE415GIBJ44HM	4	15W	2MB	1.5GHz	500MHz (HD 8330E)	DDR3-1600	Yes	90°C
GX-217GA	GE217GIBJ23HM	2	15W	1MB	1.65GHz	450MHz (HD 8280E)	DDR3-1600	Yes	90°C
GX-210HA	GE210HICJ23HM	2	9W	1MB	1.0GHz	300MHz (HD 8210E)	DDR3-1333	Yes	90°C
w/o GPU									
GX-416RA	GE416RIBJ44HM	4	15W	2MB	1.6GHz	N/A	DDR3-1600	N/A	90oC

### ARCHITECTURAL OVERVIEW OF THE AMD G-SERIES SOC



#### HIGH PERFORMANCE BOX PC WITH AMD G-SERIES SOC

\*Compared to AMD Embedded G-Series APU

#### **1ST GENERATION APU SOC DESIGN**

- > Integrates Controller Hub functional block as well as CPU+GPU+NB
- > 28nm process technology, FT3 BGA package, 24.5mm x 24.5mm
- > Dual- or Quad-"Jaguar" CPU cores with 2MB shared L2 cache

#### NEXT GENERATION GRAPHICS CORE

- > Compute performance (GFLOP) improvement
- > DirectX® 11.1 graphics support

#### **MEMORY SUPPORT: SINGLE-CHANNEL DDR3**

- > Up to 2 UDIMMs or 2 SO-DIMM DDR3-1600 @ 1.35V & 1.25V
- > Support for ECC DIMMs

#### **INTEGRATED DISPLAY OUTPUTS**

- > Supports two simultaneous displays
- > Supports 4-lane DisplayPort 1.2, DVI, HDMI<sup>™</sup> 1.4a, Integrated VGA and Integrated eDP or 18bpp single channel LVDS

#### **UPDATED I/O**

- > Four x1 links of PCIe® Gen 2 for GPPs
- > One x4 link of PCIe Gen 2 for discrete GPU (not on lower TDPs)
- > 8 USB 2.0 + 2 USB 3.0
- > 2 SATA 2.x/3.x (up to 6Gb/s)
- > SD Card Reader v3.0 or SDIO controller

## www.amd.com/embedded

- 1 The low-power x86 microprocessor class includes: GX-420CA @ 25W TDP (scored 19); GX-415GA @ 15W (25), GX-217GA @ 15W (17), GX-210HA @ 9W (20), GT-56N @ 18W (12), G-752R @ 18W (7), G-740N @9W (14), G-716R @ 4.5W (19), Intel Atom NZ70 @ 2.5W (20), Intel Atom D525 @ 13W (9), Intel Atom D2700 @ 10W (12) & Intel Celeron G440 @ 35W (5). Performance score based on an average of scores from the following benchmarks: Sandra Engineering 2011 Dhrystone ALU, Sandra Engineering, 2011 Whetstone iSSE3, 3DMark® 06 (1280 x 1024), PassMark Performance Test 7.0 2D Graphics Mark, and EEMBC CoreMark. All configurations used DirectX 11.0. AMD G-Series APU system running Windows® 7 Ultimate for Sandra Engineering, 3DMark® 06 and PassMark. All systems running Undows® 7 Ultimate for Sandra Engineering. SDMark® 06 and PassMark. All systems running Undows® 7 Ultimate for Sandra Engineering. SDMark® 06 and PassMark. All systems running UNdows® 7 Ultimate for Sandra Engineering. SIMMark® 06 and PassMark. All systems running Windows® 7 Ultimate for Sandra Engineering. SIMMark® 06 and PassMark. All systems running Windows® 7 Ultimate for Sandra Engineering. SIMMark® 06 and PassMark. All systems running Windows® 7 Ultimate for Sandra Engineering. SIMMark® 06 and PassMark. All systems running Windows® 7 Ultimate for Sandra Engineering. SIMMark® 06 and PassMark. All systems running Windows® 7 Ultimate for Sandra Engineering. SIMMark® 06 and PassMark. All systems running Windows® 7 Ultimate for Sandra Engineering. SIMMark® 06 and PassMark Lile System Sustem Songravitation used AMB "Larre" Reference Design Board with 4GB DDR3 and integrated graphics. Intel Atom D2700 waste toos with Jatk WOKDL-2700 motherboard, 4GB DDR3 and integrated graphics. Intel Atom 270 system configuration used MSI H61M-P23 motherboard with AgB DDR3 and integrated graphics. Intel Atom 270 system configuration used MSI H61M-P23 motherboard with pastomark and integrated graphics. Intel Atom 270 system configuration used MSI H61M-P23 motherboard with hatford DDR3 and integr motherboard with platform integrated 1GB DDR3 and integrated graphics.
- 2 AMD GX-415GA scored 209, AMD G-T56N scored 98, and Intel Atom D525 scored 93, based on an average of Sandra Engineering 2011 Dhyrstone, Sandra Engineering 2011 Whetstone and EEMBC CoreMark Multi-Ihread benchmark results. AMD G-T56N system configuration used IBase MI958 motherboard with 4GB DDR3 and integrated graphics. AMD GX-415GA system configuration used AMD "Larne" Reference Design Board with 4GB DDR3 and integrated graphics. Intel Atom D525 system configuration used MSI MS-A923 motherboard with platform integrated 1GB DDR3 and integrated graphics. All systems running Windows® 7 Ultimate for Sandra Engineering and Ubuntu version 11.10 for EEMBC CoreMark.

- 5 AMD G-Series SOC FT3 BGA package dimension 24.5mm x 24.5mm = 600.25 mm2 SOC; AMD G-Series APU FT1 and Controller Hub two-chip platform: 19mm x 19mm + 23mm x 23mm = 890 mm2; 33% improvement 6 Based on an average of Sandra Engineering 2011 Dhrystone ALU, Sandra Engineering 2011 Whetstone iSSE3, 3DMark<sup>®</sup> 06 (1280 x 1024), PassMark Performance Test 7.0 zD Graphics Mark, and EEMBC CoreMark Multi-thread. AMD G-T56N system configuration used iBase MI958 motherboard with 4GB DDR3 and integrated graphics. AMD GX-415GA system configuration used AMD "Larne" Reference Design Board with 4GB DDR3 and integrated graphics. All systems running Windows<sup>®</sup> 7 Ultimate for Sandra Engineering, 3DMark<sup>®</sup> 06 (1280 x 1024), PassMark Performance Test 7.0 zD Graphics Mark, and EMBC CoreMark Multi-thread. AMD G-T56N system configuration used iBase MI958 motherboard with 4GB DDR3 and integrated graphics. AMD GX-415GA system configuration used AMD "Larne" Reference Design Board with 4GB DDR3 and integrated graphics. All configurations used DirectX 11.0.
- 7 Based on an average of Sandra Engineering 2011 Dhyrstone, Sandra Engineering 2011 Whetstone and EEMBC CoreMark Multi-thread benchmark results. AMD G-T56N system configuration used iBase MI958 motherboard with 4GB DDR3 and integrated graphics. AMD GX-415GA system configuration used AMD "Larne" Reference Design Board with 4GB DDR3 and integrated graphics. All systems running Windows<sup>®</sup> 7 Ultimate for Sandra Engineering and Ubuntu version 11.10 for EEMBC CoreMark.
- 8 AMD GX-415GA scored 864, AMD G-T56N scored 724, and Intel Atom D525 scored 162, based on an average of 3DMark® 06 1280x1024 and PassMark Performance Test 7.0 2D Graphics Suite benchmark results. AMD G-T56N system configuration used iBase MI958 motherboard with 4GB DDR3 and integrated graphics. IAID GX-415GA system configuration used AMD "Lane" Reference Design Board with 4GB DDR3 and integrated fraphics. IAID and integrated graphics. All Systems running Windows® 7 Ultimate with DirectX 11.0.
- 9 OpenCL 1.2 currently supported in the following operating systems: Microsoft Windows 7; Microsoft Windows Embedded Standard 7; Microsoft Windows 8; Microsoft Windows 8; Microsoft Windows Embedded Standard 8; Linux(Catalyst drivers). OpenGL 4.2 currently supported in the following operating systems: Microsoft Windows 7; Microsoft Windows 7; Microsoft Windows 7; Microsoft Windows 8; Microsoft Windows Embedded Standard 7; Microsoft Windows 8; Microsoft Windows Embedded Standard 7; Microsoft Windows 8; Microsoft Windows Embedded Standard 8; Linux(Catalyst drivers). Ongoing support options TBA.

©2013 Advanced Micro Devices, Inc. All rights reserved. AMD, the AMD arrow logo, Radeon, and combinations thereof are trademarks of Advanced Micro Devices, Inc. DirectX and Windows are registered trademarks of Microsoft Corporation in the U.S. and/or other jurisdictions. HDMI is a trademark of HDMI Licensing, LLC. OpenCL is a trademark of Apple Inc. used by permission by Khronos. PCIe and PCI Express are registered trademarks of PCI-SIG. 3DMark is a trademark of Futuremark Corporation. All other names used in this publication are for informational purposes only and may be trademarks of their respective owners. PID: 53377-A

